

Property of Lite-On Only

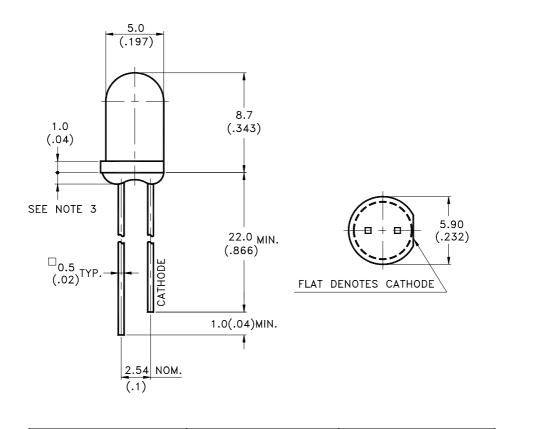
Features

- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on P.C. board or panel.
- * I.C. Compatible/low current requirements.
- * Popular T-13/4 diameter.

Package Dimensions



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Part No.	Lens	Source Color
LTL2P38RKW	Water Clear	AlInGaP Red

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

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Part No. : LTL2P.	8RKW	Page :	1	of	9	



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Parameter	Maximum Rating	Unit		
Power Dissipation	120	mW		
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	130	mA		
DC Forward Current	50	mA		
Derating Linear From 40°C	0.75	mA/°C		
Reverse Voltage	5	5 V		
Operating Temperature Range	-40°C to + 80°C			
Storage Temperature Range	-55°C to + 100°C			
Lead Soldering Temperature [1.6mm(.063") From Body]	270°C for 6 Seconds			

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Part No. : LTL2P38RKW Page : 2 of 9

BNS-OD-C131/A4

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Radiant Intensity	Ie	10.2		30.5	mW/sr	$I_F = 20 m A$
Viewing Angle	2 0 1/2		22		deg	Note 2 (Fig.5)
Peak Emission Waveleng	th λ _P		632		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λ_{d}		624		nm	Note 4
Spectral Line Half-Width	Δλ		20		nm	
^m Forward Voltage	VF	DataShee	^{t4U} 2.0 ^m	2.4	V	$I_F = 20 m A$
Reverse Current	Ir			100	μA	$V_R = 5V$

NOTE:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Radiometric Intensity (mW/sr at 20mA)

Bin	Min.	Max.
L	10.2	12.3
М	12.3	14.7
N	14.7	17.7
Р	17.7	21.2
Q	21.2	25.4
R	25.4	30.5

Note: Tolerance for each bin will be $\pm 15\%$

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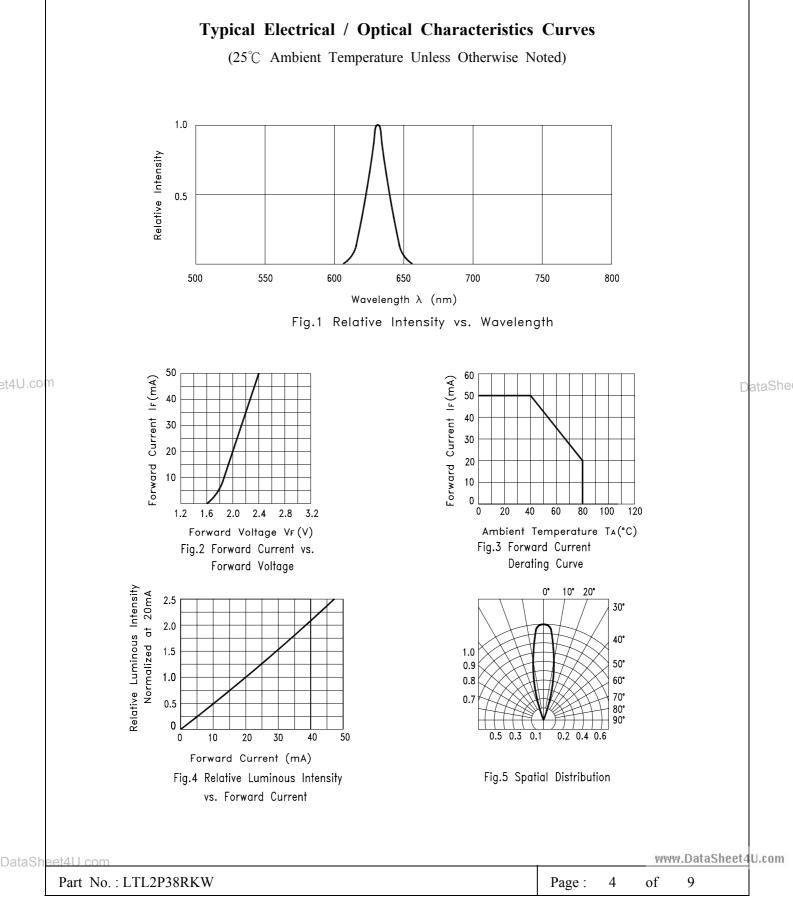
Part No. : LTL2P38RKW Page : 3 of 9

BNS-OD-C131/A4

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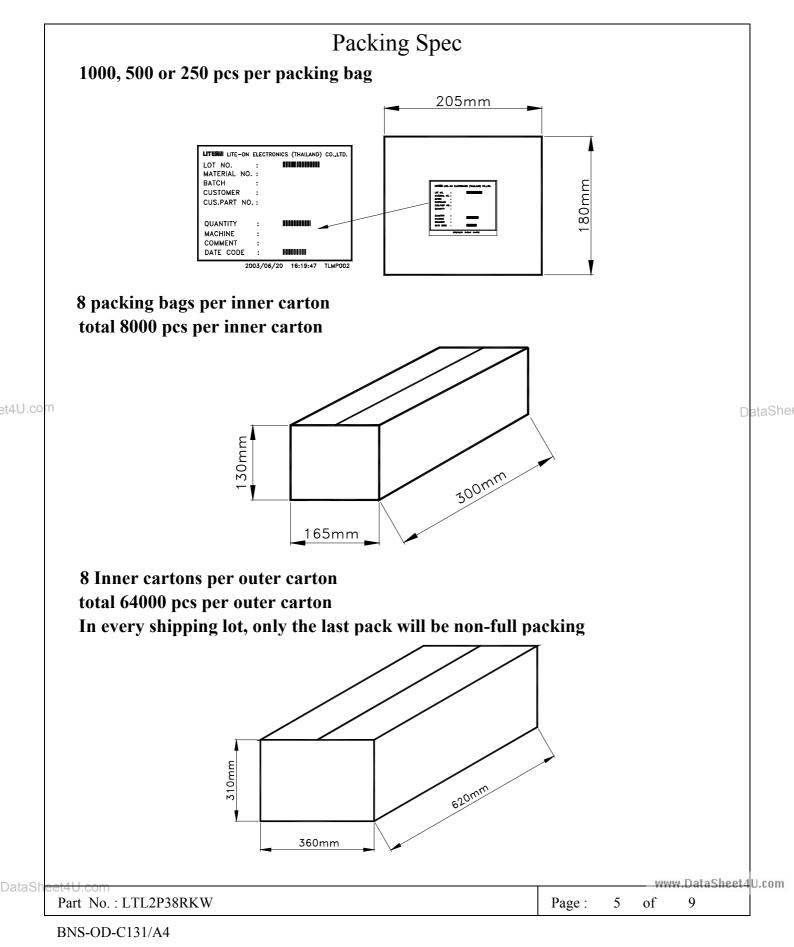
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BNS-OD-C131/A4



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CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering conditions :

Soldering iron		Wave soldering		
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

Part No. : LTL2P38RKW

www.DataSheet4U.com Page :

6 of 9 DataShe

BNS-OD-C131/A4



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	6. Drive Method					
	An LED is a current-operated device. In order to ensure intensity uniformity on n connected in parallel in an application, it is recommended that a current limiting r incorporated in the drive circuit, in series with each LED as shown in Circuit A be	resistor be	Ds			
	Circuit model A Circuit model B	•				
]—				
	(A) Recommended circuit(B) The brightness of each LED might appear different due to the differences in the of those LEDs	the I-V char	racter	istics		
t4U.col	 7. ESD (Electrostatic Discharge) Static Electricity or power surge will damage the LED et4U.com Suggestions to prevent ESD damage: Use a conductive wrist band or anti- electrostatic glove when handling these L 	EDs			I	DataS
	 All devices, equipment, and machinery must be properly grounded Work tables, storage racks, etc. should be properly grounded Use ion blower to neutralize the static charge which might have built up on su plastic lens as a result of friction between LEDs during storage and handing 	rface of the	LED	S		
	plastic lens as a result of metion between LED's during storage and handing					
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BNS-OD-C131/A4

Suggested checking list :	
Training and Certification	
1. Everyone working in a static-safe area is ESD-certifi	ed?
2. Training records kept and re-certification dates moni	
Static-Safe Workstation & Work Areas	
1. Static-safe workstation or work-areas have ESD sign	IS?
2. All surfaces and objects at all static-safe workstation	and within 1 ft measure less than 100V?
3. All ionizer activated, positioned towards the units?	
4. Each work surface mats grounding is good?	
Personnel Grounding	
1. Every person (including visitors) handling ESD sens	itive (ESDS) items wear wrist strap, heel strap or
conductive shoes with conductive flooring?2. If conductive footwear used, conductive flooring also	o present where operator stand or walk?
3. Garments, hairs or anything closer than 1 ft to ESD i	
4. Every wrist strap or heel strap/conductive shoes chec	
5. All wrist strap or heel strap checkers calibration up to	-
Note: *50V for Blue LED. DataSheet4	U.com
Device Handling	
1. Every ESDS items identified by EIA-471 labels on it	· · · ·
2. All ESDS items completely inside properly closed st	atic-shielding containers when not at static-safe
workstation?	
3. No static charge generators (e.g. plastics) inside shiel4. All flexible conductive and dissipative package mate	-
Others	That's inspected before reuse of recycle?
1. Audit result reported to entity ESD control coordinat	tor?
2. Corrective action from previous audits completed?	
3. Are audit records complete and on file?	
U.com	www.Data
rt No. : LTL2P38RKW	Page: 8 of 9

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	Classification	Test Item	Test Condition	Reference Standard
		Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
		High Temperature High Humidity Storage	Ta= $65\pm5^{\circ}C$ RH= 90 ~ 95% Test Time= 240HRS \pm 2HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)
	Endurance Test	High Temperature High Humidity Reverse BIAS	Ta= $65\pm5^{\circ}$ C RH= 90 ~ 95% VR=5V Test Time = 500HRS (-24HRS, +48HRS)	JIS C 7021 : B-11(1982)
	High Temperature Storage Low Temperature Storage	• •	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
m		DataSheet4U.com Ta= -55±5℃ *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)	
		Temperature Cycling	105° C ~ 25° C ~ -55° C ~ 25° C 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)
	Environmental	Thermal Shock	$105 \pm 5^{\circ}C \sim -55^{\circ}C \pm 5^{\circ}C$ 10mins 10mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
	Test	Solder Resistance	T.sol = $260 \pm 5^{\circ}$ C Dwell Time= 10 ± 1 secs	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)
		Solderability	T. sol = $230 \pm 5^{\circ}$ C Dwell Time= 5 ± 1 secs	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)

9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

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Part No. : LTL2P38RKW

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